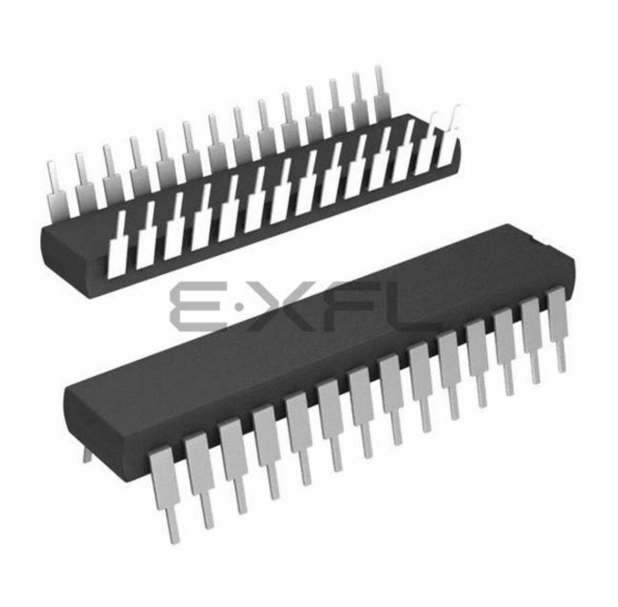

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I²C, IrDA, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	19
Program Memory Size	64KB (22K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 9x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24fj64gb002-i-sp

2.0 GUIDELINES FOR GETTING STARTED WITH 16-BIT MICROCONTROLLERS

2.1 Basic Connection Requirements

Getting started with the PIC24FJ64GB004 family of 16-bit microcontrollers requires attention to a minimal set of device pin connections before proceeding with development.

The following pins must always be connected:

- All VDD and VSS pins
  (see **Section 2.2 "Power Supply Pins"**)
- All AVDD and AVSS pins, regardless of whether or not the analog device features are used
  (see **Section 2.2 "Power Supply Pins"**)
- $\overline{\text{MCLR}}$ pin
  (see **Section 2.3 "Master Clear (MCLR) Pin"**)
- ENVREG/DISVREG and VCAP/VDDCORE pins (PIC24FJ devices only)
  (see **Section 2.4 "Voltage Regulator Pins (ENVREG/DISVREG and VCAP/VDDCORE)"**)

These pins must also be connected if they are being used in the end application:

- PGECx/PGEDx pins used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes
  (see **Section 2.5 "ICSP Pins"**)
- OSCI and OSCO pins when an external oscillator source is used
  (see **Section 2.6 "External Oscillator Pins"**)

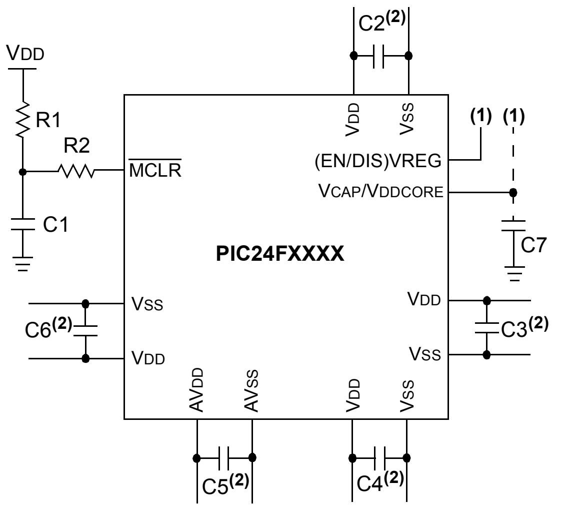
Additionally, the following pins may be required:

- VREF+/VREF- pins used when external voltage reference for analog modules is implemented

Note:	The AVDD and AVSS pins must always be connected, regardless of whether any of the analog modules are being used.

The minimum mandatory connections are shown in Figure 2-1.

FIGURE 2-1: RECOMMENDED MINIMUM CONNECTIONS



Key (all values are recommendations):

C1 through C6: 0.1 µF, 20V ceramic

C7: 10 µF, 6.3V or greater, tantalum or ceramic

R1: 10 kΩ

R2: 100Ω to 470Ω

Note 1: See **Section 2.4 "Voltage Regulator Pins (ENVREG/DISVREG and VCAP/VDDCORE)"** for explanation of ENVREG/DISVREG pin connections.

2: The example shown is for a PIC24F device with five VDD/VSS and AVDD/AVSS pairs. Other devices may have more or less pairs; adjust the number of decoupling capacitors appropriately.

2.6 External Oscillator Pins

Many microcontrollers have options for at least two oscillators: a high-frequency primary oscillator and a low-frequency secondary oscillator (refer to **Section 8.0 "Oscillator Configuration"** for details).

The oscillator circuit should be placed on the same side of the board as the device. Place the oscillator circuit close to the respective oscillator pins with no more than 0.5 inch (12 mm) between the circuit components and the pins. The load capacitors should be placed next to the oscillator itself, on the same side of the board.

Use a grounded copper pour around the oscillator circuit to isolate it from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed.

Layout suggestions are shown in Figure 2-4. In-line packages may be handled with a single-sided layout that completely encompasses the oscillator pins. With fine-pitch packages, it is not always possible to completely surround the pins and components. A suitable solution is to tie the broken guard sections to a mirrored ground layer. In all cases, the guard trace(s) must be returned to ground.

In planning the application's routing and I/O assignments, ensure that adjacent port pins and other signals in close proximity to the oscillator are benign (i.e., free of high frequencies, short rise and fall times and other similar noise).

For additional information and design guidance on oscillator circuits, please refer to these Microchip Application Notes, available at the corporate web site (www.microchip.com):

- *AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC™ and PICmicro® Devices"*
- *AN849, "Basic PICmicro® Oscillator Design"*
- *AN943, "Practical PICmicro® Oscillator Analysis and Design"*
- *AN949, "Making Your Oscillator Work"*

FIGURE 2-4: SUGGESTED PLACEMENT OF THE OSCILLATOR CIRCUIT

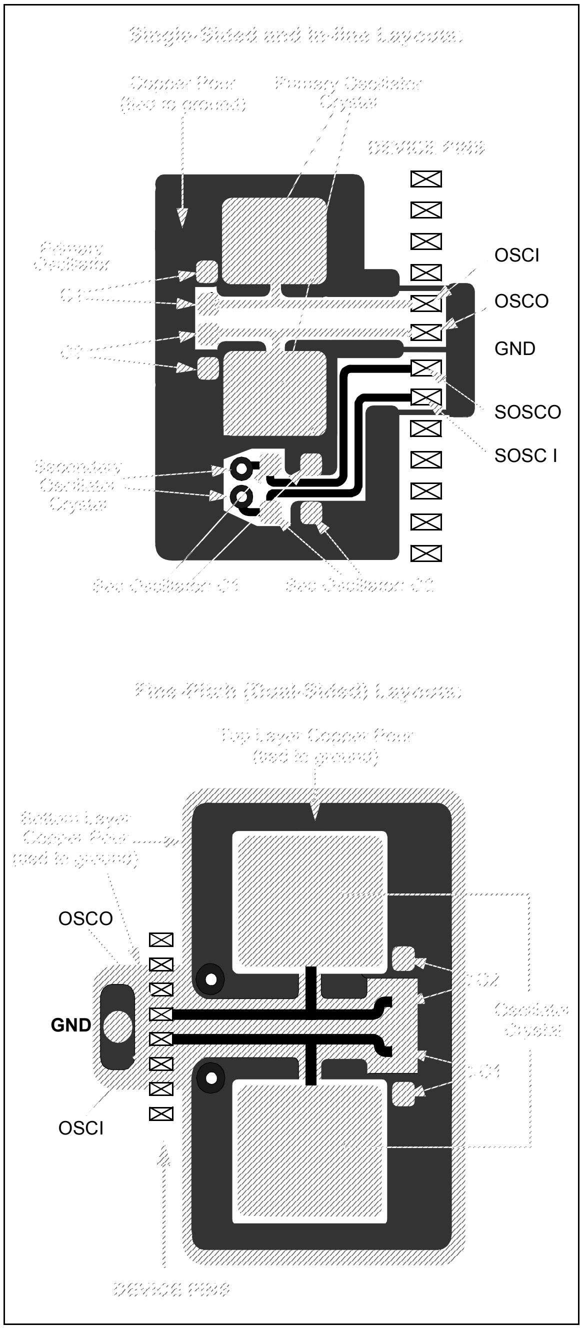


TABLE 4-6: TIMER REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TMR1	0100	Timer1 Register																0000
PR1	0102	Timer1 Period Register																FFFF
T1CON	0104	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	—	TSYNC	TCS	—	0000
TMR2	0106	Timer2 Register																0000
TMR3HLD	0108	Timer3 Holding Register (for 32-bit timer operations only)																0000
TMR3	010A	Timer3 Register																0000
PR2	010C	Timer2 Period Register																FFFF
PR3	010E	Timer3 Period Register																FFFF
T2CON	0110	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	T32	—	TCS	—	0000
T3CON	0112	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	—	—	TCS	—	0000
TMR4	0114	Timer4 Register																0000
TMR5HLD	0116	Timer5 Holding Register (for 32-bit operations only)																0000
TMR5	0118	Timer5 Register																0000
PR4	011A	Timer4 Period Register																FFFF
PR5	011C	Timer5 Period Register																FFFF
T4CON	011E	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	T32	—	TCS	—	0000
T5CON	0120	TON	—	TSIDL	—	—	—	—	—	—	TGATE	TCKPS1	TCKPS0	—	—	TCS	—	0000

Legend: — = unimplemented, read as ‘0’. Reset values are shown in hexadecimal.

REGISTER 6-1: RCON: RESET CONTROL REGISTER[1]

R/W-0, HS	R/W-0, HS	U-0	U-0	U-0	R/CO-0, HS	R/W-0, HS	R/W-0
TRAPR	IOPUWR	—	—	—	DPSLP	CM	PMSLP
bit 15							bit 8

R/W-0, HS	R/W-0, HS	R/W-0	R/W-0, HS	R/W-0, HS	R/W-0, HS	R/W-1, HS	R/W-1, HS
EXTR	SWR	SWDTEN[2]	WDTO	SLEEP	IDLE	BOR	POR
bit 7							bit 0

Legend:	CO = Clearable Only bit	HS = Hardware Settable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **TRAPR:** Trap Reset Flag bit
1 = A Trap Conflict Reset has occurred
0 = A Trap Conflict Reset has not occurred

bit 14 **IOPUWR:** Illegal Opcode or Uninitialized W Access Reset Flag bit
1 = An illegal opcode detection, an illegal address mode or uninitialized W register used as an Address Pointer caused a Reset
0 = An illegal opcode or uninitialized W Reset has not occurred

bit 13-11 **Unimplemented:** Read as ‘0’

bit 10 **DPSLP:** Deep Sleep Mode Flag bit
1 = Deep Sleep has occurred
0 = Deep Sleep has not occurred

bit 9 **CM:** Configuration Word Mismatch Reset Flag bit
1 = A Configuration Word Mismatch Reset has occurred
0 = A Configuration Word Mismatch Reset has not occurred

bit 8 **PMSLP:** Program Memory Power During Sleep bit
1 = Program memory bias voltage remains powered during Sleep
0 = Program memory bias voltage is powered down during Sleep and the voltage regulator enters Standby mode

bit 7 **EXTR:** External Reset ($\overline{\text{MCLR}}$) Pin bit
1 = A Master Clear (pin) Reset has occurred
0 = A Master Clear (pin) Reset has not occurred

bit 6 **SWR:** Software Reset (Instruction) Flag bit
1 = A RESET instruction has been executed
0 = A RESET instruction has not been executed

bit 5 **SWDTEN:** Software Enable/Disable of WDT bit[2]
1 = WDT is enabled
0 = WDT is disabled

bit 4 **WDTO:** Watchdog Timer Time-out Flag bit
1 = WDT time-out has occurred
0 = WDT time-out has not occurred

bit 3 **SLEEP:** Wake From Sleep Flag bit
1 = Device has been in Sleep mode
0 = Device has not been in Sleep mode

bit 2 **IDLE:** Wake-up From Idle Flag bit
1 = Device has been in Idle mode
0 = Device has not been in Idle mode

Note 1: All of the Reset status bits may be set or cleared in software. Setting one of these bits in software does not cause a device Reset.

2: If the FWDTEN Configuration bit is ‘1’ (unprogrammed), the WDT is always enabled, regardless of the SWDTEN bit setting.

TABLE 6-3: RESET DELAY TIMES FOR VARIOUS DEVICE RESETS

Reset Type	Clock Source	$\overline{\text{SYSRST}}$ Delay	System Clock Delay	Notes
POR(6)	EC	TPOR + TRST + TPWRT	—	**1, 2, 3**
	FRC, FRCDIV	TPOR + TRST + TPWRT	TFRC	**1, 2, 3, 4**
	LPRC	TPOR + TRST + TPWRT	TLPRC	**1, 2, 3, 4**
	ECPLL	TPOR + TRST + TPWRT	TLOCK	**1, 2, 3, 5**
	FRCPLL	TPOR + TRST + TPWRT	TFRC + TLOCK	**1, 2, 3, 4, 5**
	XT, HS, SOSC	TPOR+ TRST + TPWRT	TOST	**1, 2, 3, 6**
	XTPLL, HSPLL	TPOR + TRST + TPWRT	TOST + TLOCK	**1, 2, 3, 5, 6**
BOR	EC	TRST + TPWRT	—	**2, 3**
	FRC, FRCDIV	TRST + TPWRT	TFRC	**2, 3, 4**
	LPRC	TRST + TPWRT	TLPRC	**2, 3, 4**
	ECPLL	TRST + TPWRT	TLOCK	**2, 3, 5**
	FRCPLL	TRST + TPWRT	TFRC + TLOCK	**2, 3, 4, 5**
	XT, HS, SOSC	TRST + TPWRT	TOST	**2, 3, 6**
	XTPLL, HSPLL	TRST + TPWRT	TFRC + TLOCK	**2, 3, 4, 5**
All Others	Any Clock	TRST	—	**2**

Note 1: TPOR = Power-on Reset delay.

2: TRST = Internal State Reset time.

3: TPWRT = 64 ms nominal if regulator is disabled (DISVREG tied to VDD).

4: TFRC and TLPRC = RC Oscillator start-up times.

5: TLOCK = PLL lock time.

6: TOST = Oscillator Start-up Timer (OST). A 10-bit counter waits 1024 oscillator periods before releasing the oscillator clock to the system.

7: If Two-Speed Start-up is enabled, regardless of the primary oscillator selected, the device starts with FRC, and in such cases, FRC start-up time is valid.

Note: For detailed operating frequency and timing specifications, see **Section 29.0 "Electrical Characteristics"**.

7.3 Interrupt Control and Status Registers

The PIC24FJ64GB004 family of devices implements the following registers for the interrupt controller:

- INTCON1
- INTCON2
- IFS0 through IFS5
- IEC0 through IEC5
- IPC0 through IPC21 (except IPC13, IPC14 and IPC17)
- INTTREG

Global interrupt control functions are controlled from INTCON1 and INTCON2. INTCON1 contains the Interrupt Nesting Disable (NSTDIS) bit, as well as the control and status flags for the processor trap sources. The INTCON2 register controls the external interrupt request signal behavior and the use of the Alternate Interrupt Vector Table.

The IFSx registers maintain all of the interrupt request flags. Each source of interrupt has a status bit which is set by the respective peripherals, or an external signal, and is cleared via software.

The IECx registers maintain all of the interrupt enable bits. These control bits are used to individually enable interrupts from the peripherals or external signals.

The IPCx registers are used to set the Interrupt Priority Level for each source of interrupt. Each user interrupt source can be assigned to one of eight priority levels.

The interrupt sources are assigned to the IFSx, IECx and IPCx registers in the order of their vector numbers, as shown in Table 7-2. For example, the INT0 (External Interrupt 0) is shown as having a vector number and a natural order priority of 0. Thus, the INT0IF status bit is found in IFS0<0>, the INT0IE enable bit in IEC0<0> and the INT0IP<2:0> priority bits in the first position of IPC0 (IPC0<2:0>).

Although they are not specifically part of the interrupt control hardware, two of the CPU control registers contain bits that control interrupt functionality. The ALU STATUS Register (SR) contains the IPL<2:0> bits (SR<7:5>); these indicate the current CPU interrupt priority level. The user may change the current CPU priority level by writing to the IPL bits.

The CORCON register contains the IPL3 bit, which, together with IPL<2:0>, indicates the current CPU priority level. IPL3 is a read-only bit so that trap events cannot be masked by the user software.

The interrupt controller has the Interrupt Controller Test Register (INTTREG) that displays the status of the interrupt controller. When an interrupt request occurs, its associated vector number and the new interrupt priority level are latched into INTTREG.

This information can be used to determine a specific interrupt source if a generic ISR is used for multiple vectors – such as when ISR remapping is used in bootloader applications. It also could be used to check if another interrupt is pending while in an ISR.

All interrupt registers are described in Register 7-1 through Register 7-35, on the following pages.

REGISTER 7-17: IPC0: INTERRUPT PRIORITY CONTROL REGISTER 0

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	T1IP2	T1IP1	T1IP0	—	OC1IP2	OC1IP1	OC1IP0
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	IC1IP2	IC1IP1	IC1IP0	—	INT0IP2	INT0IP1	INT0IP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as ‘0’

bit 14-12 **T1IP<2:0>:** Timer1 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as ‘0’

bit 10-8 **OC1IP<2:0>:** Output Compare Channel 1 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as ‘0’

bit 6-4 **IC1IP<2:0>:** Input Capture Channel 1 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as ‘0’

bit 2-0 **INT0IP<2:0>:** External Interrupt 0 Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

REGISTER 13-2: ICxCON2: INPUT CAPTURE x CONTROL REGISTER 2

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	—	—	—	IC32
bit 15							bit 8

R/W-0	R/W-0, HS	U-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-1
ICTRIG	TRIGSTAT	—	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0
bit 7							bit 0

Legend:	HS = Hardware Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-9 **Unimplemented:** Read as ‘0’

bit 8 **IC32:** Cascade Two IC Modules Enable bit (32-bit operation)
1 = ICx and ICy operate in cascade as a 32-bit module (this bit must be set in both modules)
0 = ICx functions independently as a 16-bit module

bit 7 **ICTRIG:** ICx Trigger/Sync Select bit
1 = Trigger ICx from source designated by SYNCSELx bits
0 = Synchronize ICx with source designated by SYNCSELx bits

bit 6 **TRIGSTAT:** Timer Trigger Status bit
1 = Timer source has been triggered and is running (set in hardware, can be set in software)
0 = Timer source has not been triggered and is being held clear

bit 5 **Unimplemented:** Read as ‘0’

bit 4-0 **SYNCSEL<4:0>:** Trigger/Synchronization Source Selection bits
11111 = Reserved
11110 = Reserved
11101 = Reserved
11100 = CTMU[(1)]
11011 = A/D[(1)]
11010 = Comparator 3[(1)]
11001 = Comparator 2[(1)]
11000 = Comparator 1[(1)]
10111 = Input Capture 4
10110 = Input Capture 3
10101 = Input Capture 2
10100 = Input Capture 1
10011 = Reserved
10010 = Reserved
1000x = Reserved
01111 = Timer5
01110 = Timer4
01101 = Timer3
01100 = Timer2
01011 = Timer1
01010 = Input Capture 5
01001 = Reserved
01000 = Reserved
00111 = Reserved
00110 = Reserved
00101 = Output Compare 5
00100 = Output Compare 4
00011 = Output Compare 3
00010 = Output Compare 2
00001 = Output Compare 1
00000 = Not synchronized to any other module

Note 1: Use these inputs as trigger sources only and never as sync sources.

REGISTER 14-2: OCxCON2: OUTPUT COMPARE x CONTROL REGISTER 2

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
FLTMD	FLTOUT	FLTTRIEN	OCINV	—	DCB1[3]	DCB0[3]	OC32
bit 15							bit 8

R/W-0	R/W-0, HS	R/W-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0
OCTRIG	TRIGSTAT	OCTRIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0
bit 7							bit 0

Legend:	HS = Hardware Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **FLTMD:** Fault Mode Select bit
1 = Fault mode is maintained until the Fault source is removed and the corresponding OCFLT0 bit is cleared in software
0 = Fault mode is maintained until the Fault source is removed and a new PWM period starts

bit 14 **FLTOUT:** Fault Out bit
1 = PWM output is driven high on a Fault
0 = PWM output is driven low on a Fault

bit 13 **FLTTRIEN:** Fault Output State Select bit
1 = Pin is forced to an output on a Fault condition
0 = Pin I/O condition is unaffected by a Fault

bit 12 **OCINV:** OCMP Invert bit
1 = OCx output is inverted
0 = OCx output is not inverted

bit 11 **Unimplemented:** Read as '0'

bit 10-9 **DCB<1:0>:** OC Pulse-Width Least Significant bits[3]
11 = Delay OCx falling edge by 3/4 of the instruction cycle
10 = Delay OCx falling edge by 1/2 of the instruction cycle
01 = Delay OCx falling edge by 1/4 of the instruction cycle
00 = OCx falling edge occurs at start of the instruction cycle

bit 8 **OC32:** Cascade Two OC Modules Enable bit (32-bit operation)
1 = Cascade module operation enabled
0 = Cascade module operation disabled

bit 7 **OCTRIG:** OCx Trigger/Sync Select bit
1 = Trigger OCx from source designated by SYNCSELx bits
0 = Synchronize OCx with source designated by SYNCSELx bits

bit 6 **TRIGSTAT:** Timer Trigger Status bit
1 = Timer source has been triggered and is running
0 = Timer source has not been triggered and is being held clear

bit 5 **OCTRIS:** OCx Output Pin Direction Select bit
1 = OCx pin is tri-stated
0 = Output compare peripheral x connected to OCx pin

Note 1: Do not use an OC module as its own trigger source, either by selecting this mode or another equivalent SYNCSEL setting.

2: Use these inputs as trigger sources only and never as sync sources.

3: These bits affect the rising edge when OCINV = 1. The bits have no effect when the OCM bits (OCxCON1<1:0>) = 001.

REGISTER 15-1: SPIxSTAT: SPIx STATUS AND CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	R-0	R-0	R-0
SPIEN(1)	—	SPISIDL	—	—	SPIBEC2	SPIBEC1	SPIBEC0
bit 15							bit 8

R-0	R/C-0, HS	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0
SRMPT	SPIROV	SRXMPT	SISEL2	SISEL1	SISEL0	SPITBF	SPIRBF
bit 7							bit 0

Legend:	C = Clearable bit	HS = Hardware Settable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **SPIEN:** SPIx Enable bit(1)

1 = Enables module and configures SCKx, SDOx, SDIx and $\overline{\text{SSx}}$ as serial port pins
0 = Disables module

bit 14 **Unimplemented:** Read as ‘0’

bit 13 **SPISIDL:** Stop in Idle Mode bit

1 = Discontinue module operation when device enters Idle mode
0 = Continue module operation in Idle mode

bit 12-11 **Unimplemented:** Read as ‘0’

bit 10-8 **SPIBEC<2:0>:** SPIx Buffer Element Count bits (valid in Enhanced Buffer mode)

Master mode:
Number of SPI transfers pending.

Slave mode:
Number of SPI transfers unread.

bit 7 **SRMPT:** Shift Register (SPIxSR) Empty bit (valid in Enhanced Buffer mode)

1 = SPIx Shift register is empty and ready to send or receive
0 = SPIx Shift register is not empty

bit 6 **SPIROV:** Receive Overflow Flag bit

1 = A new byte/word is completely received and discarded. The user software has not read the previous data in the SPIxBUF register.
0 = No overflow has occurred

bit 5 **SRXMPT:** Receive FIFO Empty bit (valid in Enhanced Buffer mode)

1 = Receive FIFO is empty
0 = Receive FIFO is not empty

bit 4-2 **SISEL<2:0>:** SPIx Buffer Interrupt Mode bits (valid in Enhanced Buffer mode)

111 = Interrupt when SPIx transmit buffer is full (SPITBF bit is set)
110 = Interrupt when last bit is shifted into SPIxSR; as a result, the TX FIFO is empty
101 = Interrupt when the last bit is shifted out of SPIxSR; now the transmit is complete
100 = Interrupt when one data is shifted into the SPIxSR; as a result, the TX FIFO has one open spot
011 = Interrupt when SPIx receive buffer is full (SPIRBF bit is set)
010 = Interrupt when SPIx receive buffer is 3/4 or more full
001 = Interrupt when data is available in receive buffer (SRMPT bit is set)
000 = Interrupt when the last data in the receive buffer is read; as a result, the buffer is empty (SRXMPT bit set)

Note 1: If SPIEN = 1, these functions must be assigned to available RPn pins before use. See **Section 10.4 “Peripheral Pin Select (PPS)”** for more information.

REGISTER 15-1: SPIxSTAT: SPIx STATUS AND CONTROL REGISTER (CONTINUED)

bit 1 **SPITBF:** SPIx Transmit Buffer Full Status bit

1 = Transmit not yet started; SPIxTXB is full
0 = Transmit started; SPIxTXB is empty

In Standard Buffer mode:
Automatically set in hardware when CPU writes SPIxBUF location, loading SPIxTXB. Automatically cleared in hardware when SPIx module transfers data from SPIxTXB to SPIxSR.

In Enhanced Buffer mode:
Automatically set in hardware when CPU writes SPIxBUF location, loading the last available buffer location. Automatically cleared in hardware when a buffer location is available for a CPU write.

bit 0 **SPIRBF:** SPIx Receive Buffer Full Status bit

1 = Receive complete, SPIxRXB is full
0 = Receive is not complete, SPIxRXB is empty

In Standard Buffer mode:
Automatically set in hardware when SPIx transfers data from SPIxSR to SPIxRXB. Automatically cleared in hardware when core reads SPIxBUF location, reading SPIxRXB.

In Enhanced Buffer mode:
Automatically set in hardware when SPIx transfers data from SPIxSR to buffer, filling the last unread buffer location. Automatically cleared in hardware when a buffer location is available for a transfer from SPIxSR.

Note 1: If SPIEN = 1, these functions must be assigned to available RPn pins before use. See **Section 10.4 "Peripheral Pin Select (PPS)"** for more information.

18.5.2 COMPLETE A CONTROL TRANSACTION TO A CONNECTED DEVICE

1. Follow the procedure described in **Section 18.5.1 “Enable Host Mode and Discover a Connected Device”** to discover a device.
2. Set up the Endpoint Control register for bidirectional control transfers by writing 0Dh to U1EP0 (this sets the EPCONDIS, EPTXEN, and EPHSHK bits).
3. Place a copy of the device framework setup command in a memory buffer. See Chapter 9 of the USB 2.0 specification for information on the device framework command set.
4. Initialize the buffer descriptor (BD) for the current (EVEN or ODD) Tx EP0, to transfer the eight bytes of command data for a device framework command (i.e., a GET DEVICE DESCRIPTOR):
   a) Set the BD data buffer address (BD0ADR) to the starting address of the 8-byte memory buffer containing the command.
   b) Write 8008h to BD0STAT (this sets the UOWN bit, and sets a byte count of 8).
5. Set the USB device address of the target device in the address register (U1ADDR<6:0>). After a USB bus Reset, the device USB address will be zero. After enumeration, it will be set to another value between 1 and 127.
6. Write D0h to U1TOK; this is a SETUP token to Endpoint 0, the target device’s default control pipe. This initiates a SETUP token on the bus, followed by a data packet. The device handshake is returned in the PID field of BD0STAT after the packets are complete. When the USB module updates BD0STAT, a transfer done interrupt is asserted (the TRNIF flag is set). This completes the setup phase of the setup transaction as referenced in Chapter 9 of the USB specification.
7. To initiate the data phase of the setup transaction (i.e., get the data for the GET DEVICE DESCRIPTOR command), set up a buffer in memory to store the received data.
8. Initialize the current (EVEN or ODD) Rx or Tx (Rx for IN, Tx for OUT) EP0 BD to transfer the data:
   a) Write C040h to BD0STAT. This sets the UOWN, configures Data Toggle (DTS) to DATA1, and sets the byte count to the length of the data buffer (64 or 40h, in this case).
   b) Set BD0ADR to the starting address of the data buffer.
9. Write the token register with the appropriate IN or OUT token to Endpoint 0, the target device’s default control pipe (e.g., write 90h to U1TOK for an IN token for a GET DEVICE DESCRIPTOR command). This initiates an IN token on the bus followed by a data packet from the device to the host. When the data packet completes, the BD0STAT is written and a transfer done interrupt is asserted (the TRNIF flag is set). For control transfers with a single packet data phase, this completes the data phase of the setup transaction as referenced in Chapter 9 of the USB specification. If more data needs to be transferred, return to step 8.
10. To initiate the status phase of the setup transaction, set up a buffer in memory to receive or send the zero length status phase data packet.
11. Initialize the current (even or odd) Tx EP0 BD to transfer the status data:
    a) Set the BDT buffer address field to the start address of the data buffer
    b) Write 8000h to BD0STAT (set UOWN bit, configure DTS to DATA0, and set byte count to 0).
12. Write the Token register with the appropriate IN or OUT token to Endpoint 0, the target device’s default control pipe (e.g., write 01h to U1TOK for an OUT token for a GET DEVICE DESCRIPTOR command). This initiates an OUT token on the bus followed by a zero length data packet from the host to the device. When the data packet completes, the BD is updated with the handshake from the device, and a transfer done interrupt is asserted (the TRNIF flag is set). This completes the status phase of the setup transaction as described in Chapter 9 of the USB specification.

Note: Only one control transaction can be performed per frame.

The B-device then proceeds by pulsing the VBUS supply. Software should do this by setting PUVBUS (U1CNFG2<4>). When an A-device detects SRP signaling (either via the ATTACHIF (U1IR<6>) interrupt or via the SESVDIF (U1OTGIR<3>) interrupt), the A-device must restore the VBUS supply by either setting VBUSON (U1OTGCON<3>), or by setting the I/O port controlling the external power source.

The B-device should not monitor the state of the VBUS supply while performing VBUS supply pulsing. When the B-device does detect that the VBUS supply has been restored (via the SESVDIF (U1OTGIR<3>) interrupt), the B-device must re-connect to the USB link by pulling up D+ or D- (via the DPPULUP or DMPULUP).

The A-device must complete the SRP by driving USB Reset signaling.

18.6.2 HOST NEGOTIATION PROTOCOL (HNP)

In USB OTG applications, a Dual Role Device (DRD) is a device that is capable of being either a host or a peripheral. Any OTG DRD must support Host Negotiation Protocol (HNP).

HNP allows an OTG B-device to temporarily become the USB host. The A-device must first enable the B-device to follow HNP. Refer to the *On-The-Go Supplement to the USB 2.0 Specification* for more information regarding HNP. HNP may only be initiated at full speed.

After being enabled for HNP by the A-device, the B-device requests being the host any time that the USB link is in Suspend state, by simply indicating a disconnect. This can be done in software by clearing DPPULUP and DMPULUP. When the A-device detects the disconnect condition (via the URSTIF (U1IR<0>) interrupt), the A-device may allow the B-device to take over as Host. The A-device does this by signaling connect as a full-speed function. Software may accomplish this by setting DPPULUP.

If the A-device responds instead with resume signaling, the A-device remains as host. When the B-device detects the connect condition (via ATTACHIF (U1IR<6>), the B-device becomes host. The B-device drives Reset signaling prior to using the bus.

When the B-device has finished in its role as Host, it stops all bus activity and turns on its D+ pull-up resistor by setting DPPULUP. When the A-device detects a suspend condition (Idle for 3 ms), the A-device turns off its D+ pull-up. The A-device may also power-down VBUS supply to end the session. When the A-device detects the connect condition (via ATTACHIF), the A-device resumes host operation, and drives Reset signaling.

18.6.3 EXTERNAL VBUS COMPARATORS

The external VBUS comparator option is enabled by setting the UVCMPDIS bit (U1CNFG2<1>). This disables the internal VBUS comparators, removing the need to attach VBUS to the microcontroller's VBUS pin.

The external comparator interface uses either the VCMPST1 and VCMPST2 pins, or the VBUSVLD, SESSVLD and SESSEND pins, based upon the setting of the UVCMPSEL bit (U1CNFG2<5>). These pins are digital inputs and should be set in the following patterns (see Table 18-3), based on the current level of the VBUS voltage.

TABLE 18-3: EXTERNAL VBUS COMPARATOR STATES

If UVCMPSEL = 0		
VCMPST1	**VCMPST2**	**Bus Condition**
0	0	VBUS < VB_SESS_END
1	0	VB_SESS_END < VBUS < VA_SESS_VLD
0	1	VA_SESS_VLD < VBUS < VA_VBUS_VLD
1	1	VBUS > VVBUS_VLD

If UVCMPSEL = 1			
VBUSVLD	**SESSVLD**	**SESSEND**	**Bus Condition**
0	0	1	VBUS < VB_SESS_END
0	0	0	VB_SESS_END < VBUS < VA_SESS_VLD
0	1	0	VA_SESS_VLD < VBUS < VA_VBUS_VLD
1	1	0	VBUS > VVBUS_VLD

REGISTER 18-7: U1CON: USB CONTROL REGISTER (DEVICE MODE)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	R-x, HSC	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	SE0	PKTDIS	—	HOSTEN	RESUME	PPBRST	USBEN
bit 7							bit 0

Legend:	U = Unimplemented bit, read as ‘0’		
R = Readable bit	W = Writable bit	HSC = Hardware Settable/Clearable bit	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-7 **Unimplemented:** Read as ‘0’

bit 6 **SE0:** Live Single-Ended Zero Flag bit
1 = Single-ended zero is active on the USB bus
0 = No single-ended zero is detected

bit 5 **PKTDIS:** Packet Transfer Disable bit
1 = SIE token and packet processing are disabled; automatically set when a SETUP token is received
0 = SIE token and packet processing are enabled

bit 4 **Unimplemented:** Read as ‘0’

bit 3 **HOSTEN:** Host Mode Enable bit
1 = USB host capability is enabled; pull-downs on D+ and D- are activated in hardware
0 = USB host capability is disabled

bit 2 **RESUME:** Resume Signaling Enable bit
1 = Resume signaling is activated
0 = Resume signaling is disabled

bit 1 **PPBRST:** Ping-Pong Buffers Reset bit
1 = Reset all Ping-Pong Buffer Pointers to the EVEN BD banks
0 = Ping-Pong Buffer Pointers are not reset

bit 0 **USBEN:** USB Module Enable bit
1 = USB module and supporting circuitry are enabled (device attached); D+ pull-up is activated in hardware
0 = USB module and supporting circuitry are disabled (device detached)

18.7.4 USB VBUS POWER CONTROL REGISTER

REGISTER 18-22: U1PWMCON: USB VBUS PWM GENERATOR CONTROL REGISTER

R/W-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
PWMEN	—	—	—	—	—	PWMPOL	CNTEN
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **PWMEN:** PWM Enable bit

1 = PWM generator is enabled
0 = PWM generator is disabled; output is held in Reset state specified by PWMPOL

bit 14-10 **Unimplemented:** Read as ‘0’

bit 9 **PWMPOL:** PWM Polarity bit

1 = PWM output is active-low and resets high
0 = PWM output is active-high and resets low

bit 8 **CNTEN:** PWM Counter Enable bit

1 = Counter is enabled
0 = Counter is disabled

bit 7-0 **Unimplemented:** Read as ‘0’

REGISTER 19-1: PMCON: PARALLEL PORT CONTROL REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PMPEN	—	PSIDL	ADRMUX1[(1)]	ADRMUX0[(1)]	PTBEEN	PTWREN	PTRDEN
bit 15							bit 8

R/W-0	R/W-0	R/W-0[(2)]	U-0	R/W-0[(2)]	R/W-0	R/W-0	R/W-0
CSF1	CSF0	ALP	—	CS1P	BEP	WRSP	RDSP
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **PMPEN:** Parallel Master Port Enable bit

1 = PMP is enabled
0 = PMP is disabled, no off-chip access performed

bit 14 **Unimplemented:** Read as ‘0’

bit 13 **PSIDL:** Stop in Idle Mode bit

1 = Discontinue module operation when device enters Idle mode
0 = Continue module operation in Idle mode

bit 12-11 **ADRMUX<1:0>:** Address/Data Multiplexing Selection bits[(1)]

11 = Reserved
10 = All 16 bits of address are multiplexed on PMD<7:0> pins
01 = Lower 8 bits of address are multiplexed on PMD<7:0> pins; upper 3 bits are multiplexed on PMA<10:8>
00 = Address and data appear on separate pins

bit 10 **PTBEEN:** Byte Enable Port Enable bit (16-Bit Master mode)

1 = PMBE port is enabled
0 = PMBE port is disabled

bit 9 **PTWREN:** Write Enable Strobe Port Enable bit

1 = PMWR/PMENB port is enabled
0 = PMWR/PMENB port is disabled

bit 8 **PTRDEN:** Read/Write Strobe Port Enable bit

1 = PMRD/$\overline{\text{PMWR}}$ port is enabled
0 = PMRD/$\overline{\text{PMWR}}$ port is disabled

bit 7-6 **CSF<1:0>:** Chip Select Function bits

11 = Reserved
10 = PMCS1 functions as chip set
01 = Reserved
00 = Reserved

bit 5 **ALP:** Address Latch Polarity bit[(2)]

1 = Active-high (PMALL and PMALH)
0 = Active-low ($\overline{\text{PMALL}}$ and $\overline{\text{PMALH}}$)

bit 4 **Unimplemented:** Read as ‘0’

bit 3 **CS1P:** Chip Select 1 Polarity bit[(2)]

1 = Active-high (PMCS1/PMCS1)
0 = Active-low ($\overline{\text{PMCS1}}$/$\overline{\text{PMCS1}}$)

Note 1: PMA<10:2> bits are not available on 28-pin devices.

2: These bits have no effect when their corresponding pins are used as address lines.

25.0 CHARGE TIME MEASUREMENT UNIT (CTMU)

> **Note:** This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the associated *"PIC24F Family Reference Manual",* **Section 11. "Charge Time Measurement Unit (CTMU)"** (DS39724).

The Charge Time Measurement Unit is a flexible analog module that provides accurate differential time measurement between pulse sources, as well as asynchronous pulse generation. Its key features include:

- Four edge input trigger sources
- Polarity control for each edge source
- Control of edge sequence
- Control of response to edges
- Time measurement resolution of 1 nanosecond
- Accurate current source suitable for capacitive measurement

Together with other on-chip analog modules, the CTMU can be used to precisely measure time, measure capacitance, measure relative changes in capacitance or generate output pulses that are independent of the system clock. The CTMU module is ideal for interfacing with capacitive-based sensors.

The CTMU is controlled through two registers: CTMUCON and CTMUICON. CTMUCON enables the module and controls edge source selection, edge source polarity selection and edge sequencing. The CTMUICON register controls the selection and trim of the current source.

25.1 Measuring Capacitance

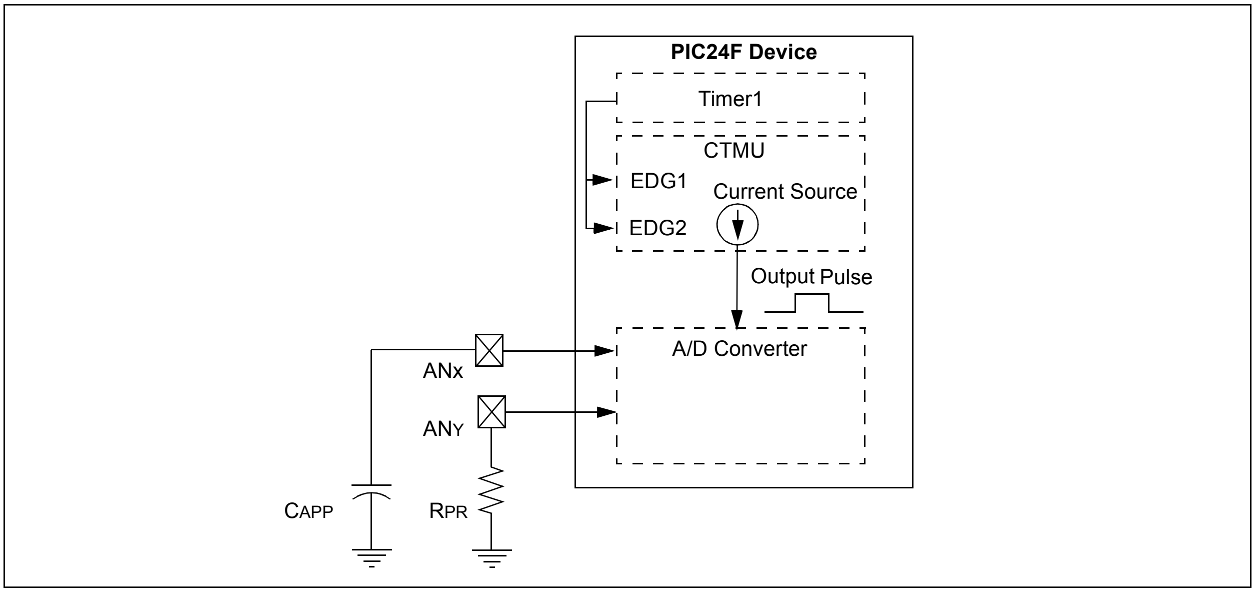
The CTMU module measures capacitance by generating an output pulse, with a width equal to the time between edge events, on two separate input channels. The pulse edge events to both input channels can be selected from four sources: two internal peripheral modules (OC1 and Timer1) and two external pins (CTEDG1 and CTEDG2). This pulse is used with the module's precision current source to calculate capacitance according to the relationship:

$$i = C \bullet \frac{dV}{dT}$$

For capacitance measurements, the A/D Converter samples an external capacitor (C_{APP}) on one of its input channels after the CTMU output's pulse. A Precision Resistor (R_{PR}) provides current source calibration on a second A/D channel. After the pulse ends, the converter determines the voltage on the capacitor. The actual calculation of capacitance is performed in software by the application.

Figure 25-1 shows the external connections used for capacitance measurements, and how the CTMU and A/D modules are related in this application. This example also shows the edge events coming from Timer1, but other configurations using external edge sources are possible. A detailed discussion on measuring capacitance and time with the CTMU module is provided in the "*PIC24F Family Reference Manual*".

FIGURE 25-1: TYPICAL CONNECTIONS AND INTERNAL CONFIGURATION FOR CAPACITANCE MEASUREMENT



26.5.2 CODE SEGMENT PROTECTION

In addition to global General Segment protection, a separate subrange of the program memory space can be individually protected against writes and erases. This area can be used for many purposes where a separate block of erase and write-protected code is needed, such as bootloader applications. Unlike common boot block implementations, the specially protected segment in the PIC24FJ64GB004 family devices can be located by the user anywhere in the program space and configured in a wide range of sizes.

Code segment protection provides an added level of protection to a designated area of program memory, by disabling the NVM safety interlock, whenever a write or erase address falls within a specified range. It does not override General Segment protection controlled by the GCP or GWRP bits. For example, if GCP and GWRP are enabled, enabling segmented code protection for the bottom half of program memory does not undo General Segment protection for the top half.

The size and type of protection for the segmented code range are configured by the WPFPx, WPEND, WPCFG and WPDIS bits in Configuration Word 3. Code segment protection is enabled by programming the WPDIS bit (= 0). The WPFP bits specify the size of the segment to be protected by specifying the 512-word code page that is the start or end of the protected segment. The specified region is inclusive, therefore, this page will also be protected.

The WPEND bit determines if the protected segment uses the top or bottom of the program space as a boundary. Programming WPEND (= 0) sets the bottom of program memory (000000h) as the lower boundary of the protected segment. Leaving WPEND unprogrammed (= 1) protects the specified page through the last page of implemented program memory, including the Configuration Word locations.

A separate bit, WPCFG, is used to independently protect the last page of program space, including the Flash Configuration Words. Programming WPCFG (= 0) protects the last page, regardless of the other bit settings. This may be useful in circumstances where write protection is needed for both a code segment in the bottom of memory, as well as the Flash Configuration Words.

The various options for segment code protection are shown in Table 26-2.

26.5.3 CONFIGURATION REGISTER PROTECTION

The Configuration registers are protected against inadvertent or unwanted changes, or reads in two ways. The primary protection method is the same as that of the RP registers – shadow registers contain a complimentary value which is constantly compared with the actual value.

To safeguard against unpredictable events, Configuration bit changes resulting from individual cell level disruptions (such as ESD events) will cause a parity error and trigger a device Reset.

The data for the Configuration registers is derived from the Flash Configuration Words in program memory. When the GCP bit is set, the source data for device configuration is also protected as a consequence. Even if General Segment protection is not enabled, the device configuration can be protected by using the appropriate code cement protection setting.

TABLE 26-2: SEGMENT CODE PROTECTION CONFIGURATION OPTIONS

Segment Configuration Bits			Write/Erase Protection of Code Segment
WPDIS	WPEND	WPCFG	
1	x	1	No additional protection enabled; all program memory protection is configured by GCP and GWRP
1	x	0	Last code page protected, including Flash Configuration Words
0	1	0	Addresses from the first address of code page, defined by WPFP<5:0> through the end of implemented program memory (inclusive), are protected, including Flash Configuration Words
0	0	0	Address, 000000h, through the last address of code page, defined by WPFP<5:0> (inclusive) is protected
0	1	1	Addresses from first address of code page, defined by WPFP<5:0> through the end of implemented program memory (inclusive), are protected, including Flash Configuration Words
0	0	1	Addresses from first address of code page, defined by WPFP<5:0> through the end of implemented program memory (inclusive), are protected

TABLE 28-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Assembly Mnemonic	Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
GOTO	GOTO Expr	Go to Address	2	2	None
	GOTO Wn	Go to Indirect	1	2	None
INC	INC f	f = f + 1	1	1	C, DC, N, OV, Z
	INC f,WREG	WREG = f + 1	1	1	C, DC, N, OV, Z
	INC Ws,Wd	Wd = Ws + 1	1	1	C, DC, N, OV, Z
INC2	INC2 f	f = f + 2	1	1	C, DC, N, OV, Z
	INC2 f,WREG	WREG = f + 2	1	1	C, DC, N, OV, Z
	INC2 Ws,Wd	Wd = Ws + 2	1	1	C, DC, N, OV, Z
IOR	IOR f	f = f .IOR. WREG	1	1	N, Z
	IOR f,WREG	WREG = f .IOR. WREG	1	1	N, Z
	IOR #lit10,Wn	Wd = lit10 .IOR. Wd	1	1	N, Z
	IOR Wb,Ws,Wd	Wd = Wb .IOR. Ws	1	1	N, Z
	IOR Wb,#lit5,Wd	Wd = Wb .IOR. lit5	1	1	N, Z
LNK	LNK #lit14	Link Frame Pointer	1	1	None
LSR	LSR f	f = Logical Right Shift f	1	1	C, N, OV, Z
	LSR f,WREG	WREG = Logical Right Shift f	1	1	C, N, OV, Z
	LSR Ws,Wd	Wd = Logical Right Shift Ws	1	1	C, N, OV, Z
	LSR Wb,Wns,Wnd	Wnd = Logical Right Shift Wb by Wns	1	1	N, Z
	LSR Wb,#lit5,Wnd	Wnd = Logical Right Shift Wb by lit5	1	1	N, Z
MOV	MOV f,Wn	Move f to Wn	1	1	None
	MOV [Wns+Slit10],Wnd	Move [Wns + Slit10] to Wnd	1	1	None
	MOV f	Move f to f	1	1	N, Z
	MOV f,WREG	Move f to WREG	1	1	N, Z
	MOV #lit16,Wn	Move 16-bit Literal to Wn	1	1	None
	MOV.b #lit8,Wn	Move 8-bit Literal to Wn	1	1	None
	MOV Wn,f	Move Wn to f	1	1	None
	MOV Wns,[Wns+Slit10]	Move Wns to [Wns + Slit10]	1	1	
	MOV Wso,Wdo	Move Ws to Wd	1	1	None
	MOV WREG,f	Move WREG to f	1	1	N, Z
	MOV.D Wns,Wd	Move Double from W(ns):W(ns + 1) to Wd	1	2	None
	MOV.D Ws,Wnd	Move Double from Ws to W(nd + 1):W(nd)	1	2	None
MUL	MUL.SS Wb,Ws,Wnd	{Wnd + 1, Wnd} = Signed(Wb) * Signed(Ws)	1	1	None
	MUL.SU Wb,Ws,Wnd	{Wnd + 1, Wnd} = Signed(Wb) * Unsigned(Ws)	1	1	None
	MUL.US Wb,Ws,Wnd	{Wnd + 1, Wnd} = Unsigned(Wb) * Signed(Ws)	1	1	None
	MUL.UU Wb,Ws,Wnd	{Wnd + 1, Wnd} = Unsigned(Wb) * Unsigned(Ws)	1	1	None
	MUL.SU Wb,#lit5,Wnd	{Wnd + 1, Wnd} = Signed(Wb) * Unsigned(lit5)	1	1	None
	MUL.UU Wb,#lit5,Wnd	{Wnd + 1, Wnd} = Unsigned(Wb) * Unsigned(lit5)	1	1	None
	MUL f	W3:W2 = f * WREG	1	1	None
NEG	NEG f	f = $\overline{f}$ + 1	1	1	C, DC, N, OV, Z
	NEG f,WREG	WREG = $\overline{f}$ + 1	1	1	C, DC, N, OV, Z
	NEG Ws,Wd	Wd = $\overline{Ws}$ + 1	1	1	C, DC, N, OV, Z
NOP	NOP	No Operation	1	1	None
	NOPR	No Operation	1	1	None
POP	POP f	Pop f from Top-of-Stack (TOS)	1	1	None
	POP Wdo	Pop from Top-of-Stack (TOS) to Wdo	1	1	None
	POP.D Wnd	Pop from Top-of-Stack (TOS) to W(nd):W(nd + 1)	1	2	None
	POP.S	Pop Shadow Registers	1	1	All
PUSH	PUSH f	Push f to Top-of-Stack (TOS)	1	1	None
	PUSH Wso	Push Wso to Top-of-Stack (TOS)	1	1	None
	PUSH.D Wns	Push W(ns):W(ns + 1) to Top-of-Stack (TOS)	1	2	None
	PUSH.S	Push Shadow Registers	1	1	None

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